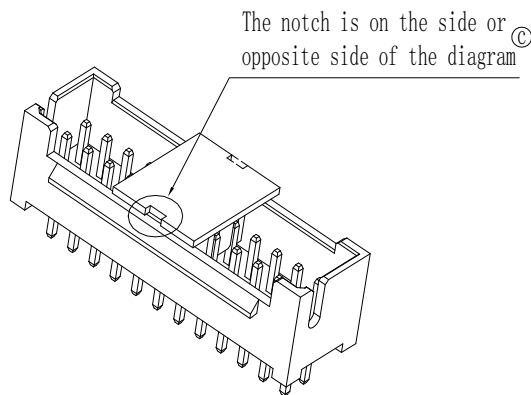
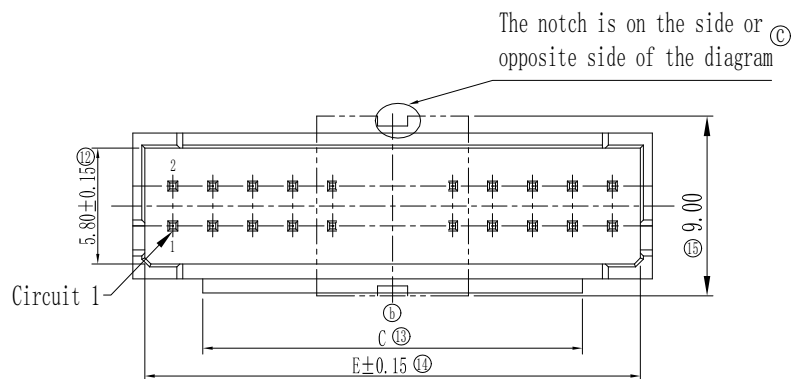
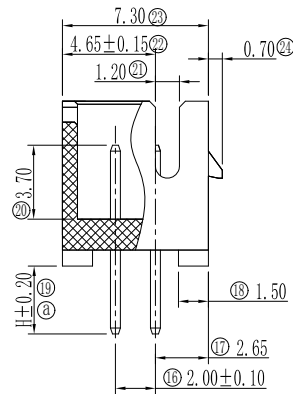
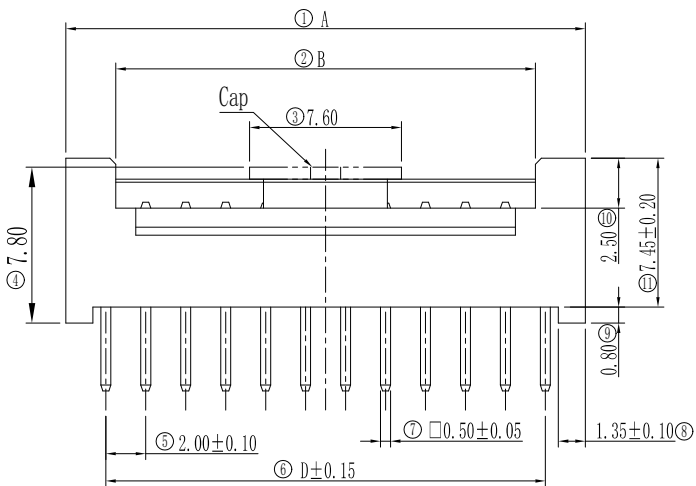
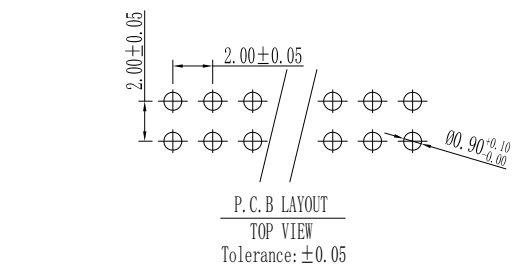




- Performance characteristics:
1. Main body part material
Insulator: LCP Nature UL94V-0
Contact terminal: Copper alloys, 1.27 μ m Min. Ni under plated, outer plating Matte Sn 3 μ m Min.
 2. Electrical requirements:
Current rating: 2 A
Voltage rating: 250 V
Contact resistance: ≤ 30 m Ω , $\Delta 10$ m Ω
Insulation resistance: ≥ 1500 M Ω
Withstanding voltage: 800 Vr.m.s, 1mA, 60s
 3. Mechanical requirements
Retention Force: ≥ 10 N/PIN(before solder)
Retention Force: ≥ 5 N/PIN(after solder)
 4. Environment specification
Working temperature: -40°C ~ +105°C
Resistance to soldering heat: 260°C, 30s
 5. Packing & storing
Method of packing: Tape & reel, outer box
Storing condition: Temperature of -10°C ~ +40°C below 80% relative humidity
 - ⑥ 6. Style of installation: Solder PCB installation (PIP)
 7. To prevent the pollution of the environment product info
RoHS agreement: In line with the European Union RoHS.

PIN NO.	A	B	C	D	E
2X12	26.00	21.00	19.00	22.00	24.80
2X09	20.00	15.00	13.00	16.00	18.80



Series code		Terminal number		Spec code		Tail length code		Plating code		Insulator material & color	
		02~24		Code	Definition	Code	Definition	Code	Definition	Code	Definition
				1	Straight male	7	3.4	B	Sn 3~5 μ m	N	LCP 本色 UL94V-0
				X	Customized	8	2.8	X	Customized	X	Customized
						X	Customized				

②	2	475571	XiaoWei Pan	2020.09.18	2.00mm Pitch Dual-Row wafer straight male	SY0. 1346. 012
①	1	413856	XiaoWei Pan	2019.09.18		
③	2	407773	XiaoWei Pan	2019.08.21		
Mark	NO.	File NO.	Signature	Date		
DRAW	qqli 2018.10.24				1346-XX1-XB-N	All Dimensions in mm Sheet 1 of 1
CHK	Tim 2022.02.26					
MAN						
STD	Juanli lai 2022.02.26					
APP	Alan 2022.02.26					

	Rev.	Weight	Scale
A3			

SHINCONN			
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Unless otherwise specified tolerance:

X.	±0.50	X.°	±3°
.X	±0.38	.X°	±2°
.XX	±0.25		